

Electronic Patent Application Fee Transmittal

Application Number:	10801475
Filing Date:	16-Mar-2004
Title of Invention:	SYSTEM FOR HEAT DISSIPATION IN SEMICONDUCTOR DEVICES
First Named Inventor/Applicant Name:	Hsien-Wei Chen
Filer:	David M. Odell/Lydia Epps-Hilliard
Attorney Docket Number:	24061.193 (TSMC2003.1410)

Filed as Large Entity

Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Utility Appl Issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1740